

The GreenMOS® high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

The GreenMOS® Generic series is optimized for extreme switching performance to minimize switching loss. It is tailored for high power density applications to meet the highest efficiency standards.

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Parameter	Value	Unit
$V_{DS, min} @ T_{j(max)}$	600	V
$I_D, pulse$	60	A
$R_{DS(ON)}, max @ V_{GS}=10V$	190	m
Q_g	17.7	nC

Product Name	Package	Marking
OSG55R190PF	TO220	OSG55R190P

Absolute Maximum Ratings at $T_j=25$ unless otherwise noted

Parameter	Symbol	Value	Unit	
Drain-source voltage	V_{DS}	550	V	
Gate-source voltage	V_{GS}	± 30	V	
Continuous drain current ¹⁾ , $T_c=25$ °C	I_D	20	A	
Continuous drain current ¹⁾ , $T_c=100$ °C		12.5		
Pulsed drain current ²⁾ , $T_c=25$ °C	$I_{D, \text{pulse}}$	60	A	
Continuous diode forward current ¹⁾ , $T_c=25$ °C	I_S	20	A	
Diode pulsed current ²⁾ , $T_c=25$ °C	$I_{S, \text{pulse}}$	60	A	
Power dissipation ³⁾ , $T_c=25$ °C	P_D	104	W	
Single pulsed avalanche energy ⁵⁾	E_{AS}	200	mJ	
MOSFET dv/dt ruggedness, V_{DS}	dv/dt	50	V/ns	
Reverse diode dv/dt, V_{DS}	SD D	dv/dt	15	V/ns
Operation and storage temperature	T_{stg}, T_j	-55 to 150	°C	

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance, junction-case	R	1.20	°C/W
Thermal resistance, junction-ambient ⁴⁾	R	62	°C/W

Electrical Characteristics at $T_j=25$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Drain-source breakdown voltage	BV_{DSS}	550			V	$V_{GS}=0$ V, $I_D=250$ uA
		600				$V_{GS}=0$ V, $I_D=250$ uA, $T_j=150$ °C
Gate threshold voltage	$V_{GS(\text{th})}$	2.7		3.7	V	$V_{DS}=V_{GS}$, $I_D=250$ uA
Drain-source on-state resistance	$R_{DS(\text{ON})}$		0.15	0.19		$V_{GS}=10$ V, $I_D=10$ A
			0.37			$V_{GS}=10$ V, $I_D=10$ A, $T_j=150$ °C
Gate-source leakage current	I_{GSS}			100	nA	$V_{GS}=30$ V
				-100		$V_{GS}=-30$ V
Drain-source leakage current	I_{DSS}			1	A	$V_{DS}=550$ V, $V_{GS}=0$ V

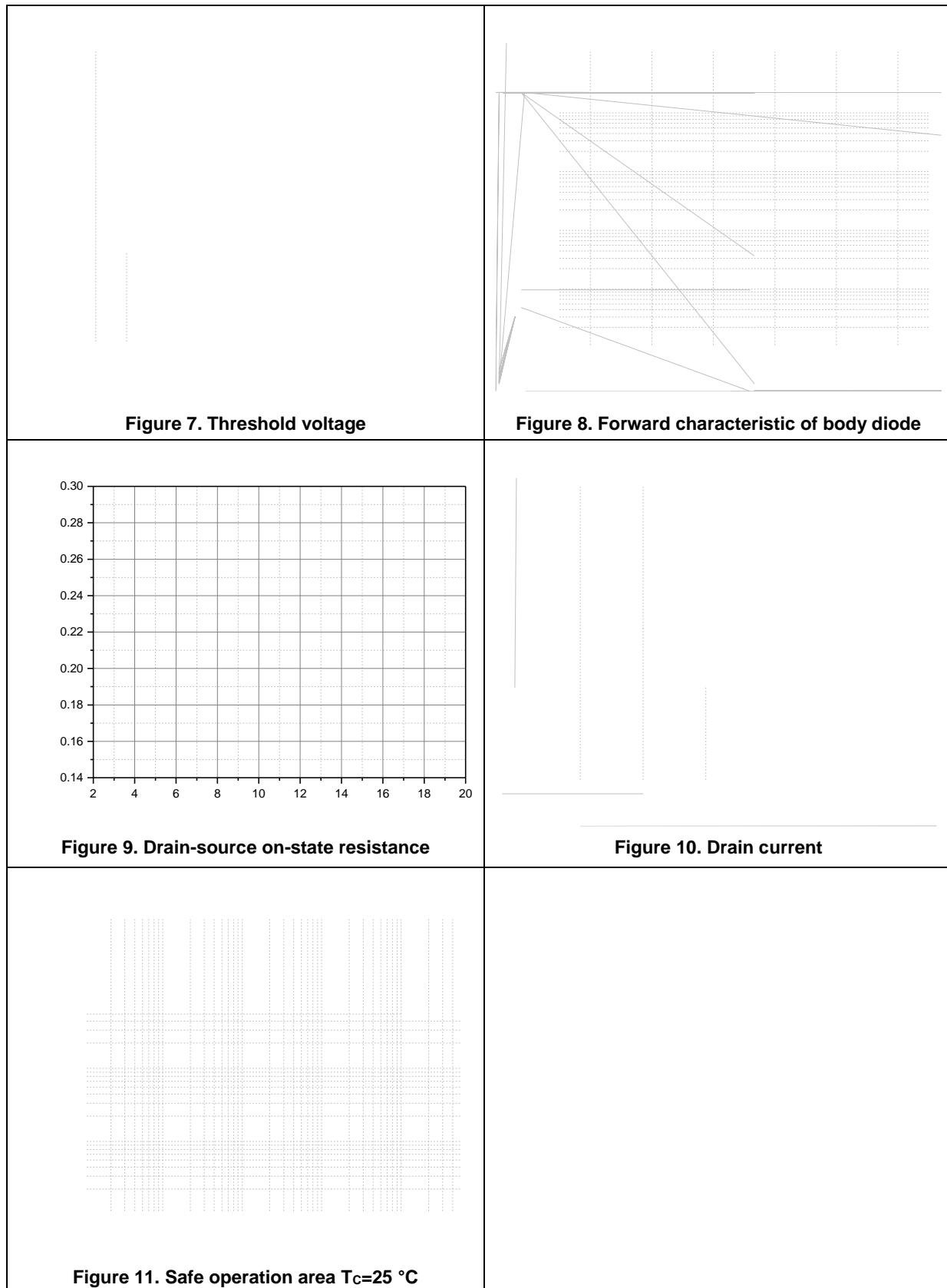
Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C _{iss}		991.4		pF	V _{GS} =0 V, V _{DS} =50 V, 00 kHz
Output capacitance	C _{oss}		125.9		pF	
Reverse transfer capacitance	C _{rss}		2.7		pF	
Turn-on delay time	t _{d(on)}		22		ns	V _{GS} =10 V, V _{DS} =400 V, R _G =2 I _D =10 A
Rise time	t _r		6.7		ns	
Turn-off delay time	t _{d(off)}		36.1		ns	
Fall time	t _f		3.5		ns	

Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	Q _g		17.7		nC	V _{GS} =10 V, V _{DS} =400 V, I _D =10 A
Gate-source charge	Q _{gs}		4		nC	
Gate-drain charge	Q _{gd}					

Electrical Characteristics Diagrams**Figure 1. Typ. output characteristics****Figure 2. Typ. transfer characteristics****Figure 3. Typ. capacitances****Figure 4. Typ. gate charge**



Test circuits and waveforms

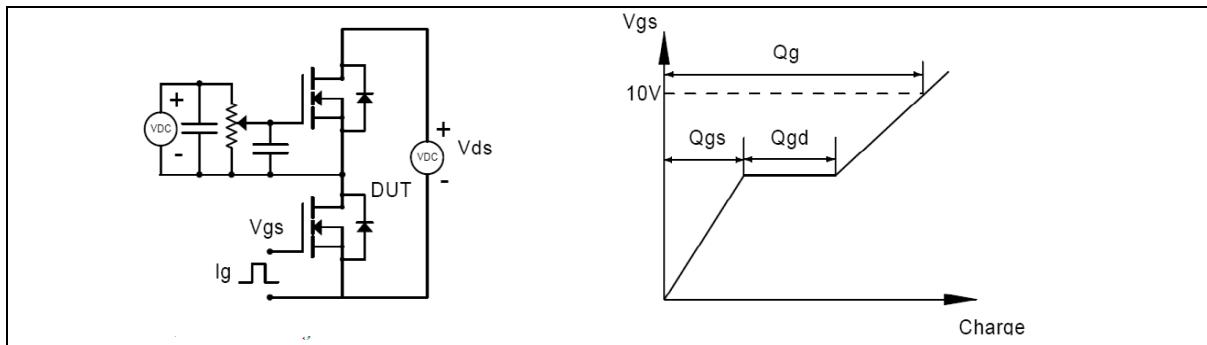


Figure 1. Gate charge test circuit & waveform

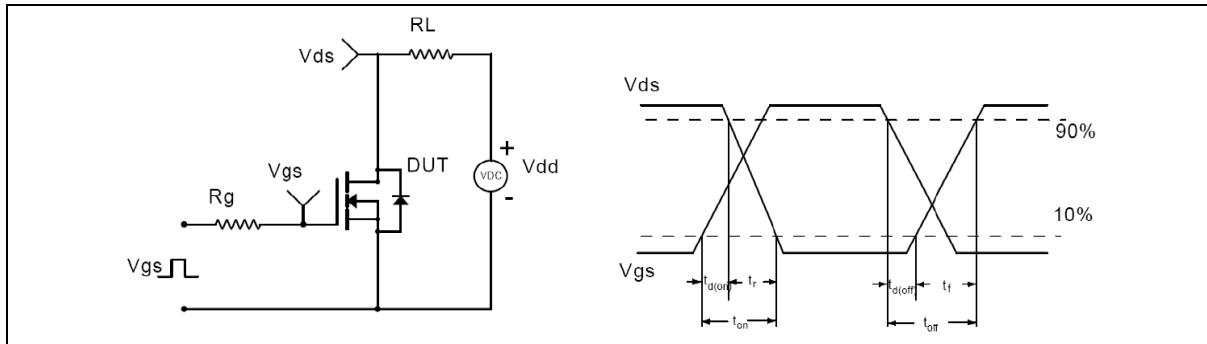


Figure 2. Switching time test circuit & waveforms

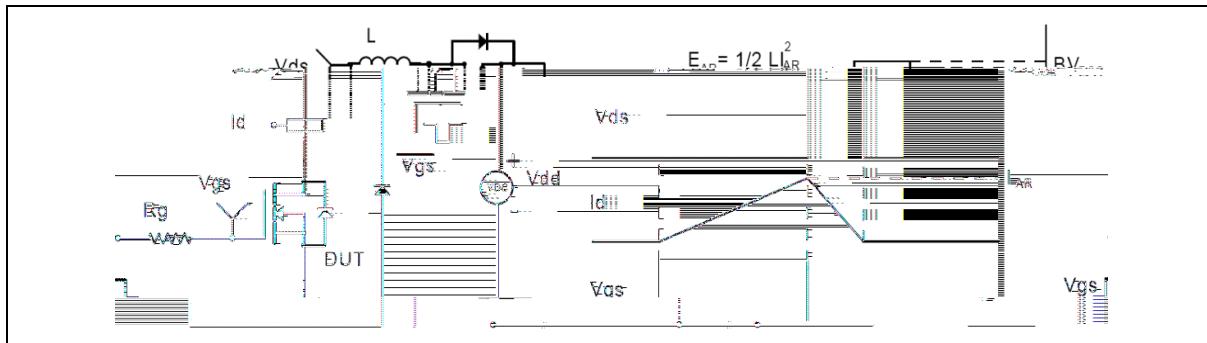
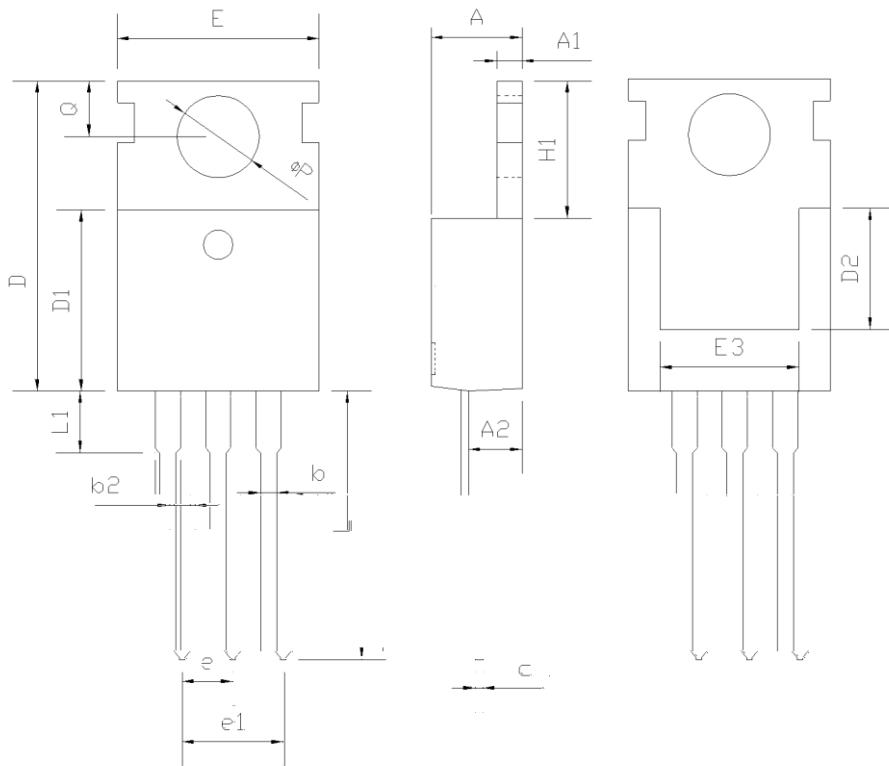


Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms



Figure 4. Diode reverse recovery test circuit & waveforms

Package Information



Symbol	mm		
	Min	Nom	Max
A	4.37	4.57	4.77
A1	1.25	1.30	1.45
A2	2.20	2.40	2.60
b	0.70	0.80	0.95
b2	1.17	1.27	1.47
c	0.40	0.50	0.65
D	15.10	15.60	16.10
D1	8.80	9.10	9.40
D2	5.50	-	-
E	9.70	10.00	10.30
E3	7.00	-	-
e	2.54 BSC		
e1	5.08 BSC		
H1	6.25	6.50	6.85
L	12.75	13.50	13.80
L1	-	3.10	3.40
	3.40	3.60	3.80
Q	2.60	2.80	3.00

Version 1: TO220-C outline dimension

Ordering Information

Package Type	Units/Tube	Tubes/Inner Box	Units/Inner Box	Inner Boxes/Carton Box	Units/Carton Box
TO220-C	50	20	1000	6	6000

Product Information

Product	Package	Pb Free	RoHS	Halogen Free
OSG55R190PF	TO220	yes	yes	yes